

# **Basic Characteristics Data**

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Model	Circuit method	Switching frequency	Input current	Inrush current	1 Ob/1 attern			Series/Parallel operation	
Model	Circuit metriod	[kHz] (reference)	[A]	protection	Material	Single sided	Double sided	Series operation	Parallel operation
MG1R5	Flyback converter	200-1500 *3	*1	-	glass fabric base,epoxy resin		Yes	Yes	*2
MG3	Flyback converter	200-1500 *3	<b>*</b> 1	-	glass fabric base,epoxy resin		Yes	Yes	<b>*</b> 2
MG15	Flyback converter	445-495	*1	-	glass fabric base,epoxy resin		Yes	Yes	<b>*</b> 2
MGF15	Flyback converter	445-495	*1	-	glass fabric base,epoxy resin		Yes	Yes	*2
MG30	Forward converter	380-460	*1	-	glass fabric base,epoxy resin		Yes	Yes	<b>*</b> 2
MGF30	Forward converter	380-460	*1	-	glass fabric base,epoxy resin		Yes	Yes	<b>*</b> 2

<sup>\*1</sup> Refer to Specification.

\*2 Refer to Instruction Manual.

\*3 The value changes depending on input and load.

## DC-DC Converters PCB Mount Type Instruction Manual



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on stress by temperature difference ----- MG-40

## 1 Pin Configuration

Table 1.1 Pin Configuration and Functions(MG1R5/MG3)

		, , ,
Pin No.	Pin Name	Function
1	-VIN	-DC Input
2	+VIN	+DC Input
4	+VOUT	+DC Output
6	-VOUT	-DC Output

<Bottom View>



(a) Single Output

Fig.1.1 Pin Configuration(MG1R5/MG3)

## 2 Function

### 2.1 Input Voltage Range

■If output voltage value doesn't fall within specifications, a unit may not operate in accordance with specifications and/or fail.

#### 2.2 Overcurrent Protection

■Overcurrent protection is built-in and comes into effect at over 105% of the rated current.

Overcurrent protection prevents the unit from short circuit and overcurrent condition. The unit automatically recovers when the fault condition is cleared.

#### 2.3 Isolation

- ■For a receiving inspection, such as Hi-Pot test, increase (decrease) the voltage gradually for a start (shut down). Avoid using Hi-Pot tester with timer because it may generate voltage a few times higher than the applied voltage, at ON/OFF of a timer.
- ■In the case of use in locations exposed to constant voltage between primary and secondary is applied, please contact us.



## 3 Wiring to Input/Output Pin

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### 3.1 Wiring input pin

#### (1) External fuse

- ■Fuse is not built-in on input side. In order to protect the unit, install the normal-blow type fuse on input side.
- ■When the input voltage from a front end unit is supplied to multiple units, install the normal-blow type fuse in each unit.

Table 3.1 Recommended fuse (Normal-blow type)

	•	• • •
Model VIN	MG1R5	MG3
5	2.0A	3.15A
12	1.6A	2.0A
24	1.0A	1.6A

- (2) External capacitor on the input side
- ■Basically, MG series does not need any external capacitor. Adding a capacitor Ci near the input pin terminal and reduce reflected input noise from a converter.

Please connect the capacitor as needed.

- ■When you use a capacitor Ci, please use the one with high frequency and good temperature characteristics.
- ■If the power supply is to be turned ON/OFF directly with a switch, inductance from the input line will induce a surge voltage several times that of the input voltage and it may damage the power supply. Make sure that the surge is absorbed, for example, by connecting an electrolytic capacitor between the input pins.
- ■If an external filter containing L (inductance) is added to the input line, or a wire from the input source to the DC-DC converter is long, not only the reflected input noise becomes large, but also the output of the converter may become unstable. In such case, connecting Ci to the input pin terminal is recommended.
- ■If you use an aluminum electrolytic capacitor, please pay attention to its ripple current rating.

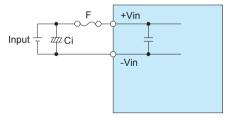


Fig3.1 Connecting an Example Capacitor to the Input Side

Table 3.2 Recommended Capacitance of an External Capacitor on the Input Side [ $\mu$ F]

Model VIN	MG1R5	MG3
5	10 - 220	10 - 220
12	10 - 100	10 - 100
24	10 - 47	10 - 47

- \*Please adjust the capacitance in accordance with a degree of the effect you want to achieve.
- (3) Reverse input voltage protection
- ■If a reverse polarity voltage is applied to the input pin terminal, the power supply will fail. If there is a possibility that a reverse polarity voltage is applied, connect a protection circuit externally as described below.

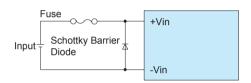


Fig3.2 Reverse input voltage protection

### 3.2 Wiring output pin

■If you want to further reduce the output ripple noise, connect an electrolytic capacitor or a ceramic capacitor Co to the output pin terminal as shown below.

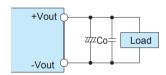


Fig.3.3 Connecting Example of an External Capacitor to the Output Side

Table 3.3 Recommended Capacitance of External Capacitor on the Output Side [ $\mu$ F]

Model VIN	MG1R5	MG3
3.3	0 - 220	0 - 220
5	0 - 220	0 - 220
12	0 - 100	0 - 100
15	0 - 100	0 - 100

- \*If you use a ceramic capacitor, keep the capacitance within the rage between about 0.1 to 22uF.
- \*Please adjust the capacitance in light of the effect you want to
- \*If you need to use an external capacitor whose capacitance exceeds the range provided in Table 3.3, please contact us.

■If the distance between the output and the load is long and therefore noise is created on the load side, connect a capacitor externally to the load as shown below.

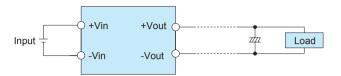


Fig3.4 Connecting Example

## 4 Series/Redundancy Operation

### 4.1 Series Operation

■Series operation is available by connecting the outputs of two or more power supplies, as shown below. Output current in series connection should be lower than the lowest rated current in each unit.

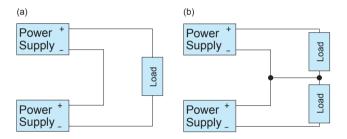


Fig.4.1 Examples of series operation

### 4.2 Redundancy Operation

- ■Parallel operation is not possible.
- ■Redundancy operation is available by wiring as shown below.

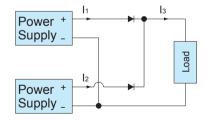


Fig.4.2 Redundancy operation

■Even a slight difference in output voltage can affect the balance between the values of I1 and I2. Please make sure that the value of I<sub>3</sub> does not exceed the rated current for each power supply.

I<sub>3</sub> ≦ Rated Current Value

## 5 Input Voltage/Current Range

- ■If you use a non-regulated power source for input, please check and make sure that its voltage fluctuation range and ripple voltage do not exceed the input voltage range shown in specifications.
- ■Please select an input power source with enough capacity, taking into consideration of the start-up current (Ip), which flows when a DC-DC converter starts up.

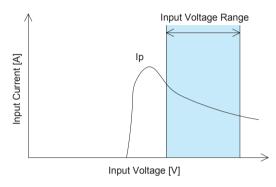


Fig.5.1 Input Current Characteristics

## 6 Assembling and Installation

### 6.1 Installation

■When two or more power supplies are used side by side, position them with proper intervals to allow enough air ventilation. Ambient temperature around each power supply should not exceed the temperature range shown in derating curve.

### 6.2 Soldering Conditions

(1) Flow Soldering : 260°C 15 seconds or less

(2) Soldering Iron: maximum 360°C 5 seconds or less

#### 6.3 Stress to Pin

- ■Applying excessive stress to the input or output pins of the power module may damage internal connections. Avoid applying stress in excess of that shown in Fig. 6.1.
- ■Input/output pin are soldered to the PCB internally. Do not pull or bend a lead powerfully.

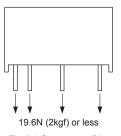


Fig.6.1 Stress onto Pins

- ■If it is expected that stress is applied to the input/output pin due to vibration or impact, reduce the stress to the pin by taking such measures as fixing the unit to the PCB by silicone rubber, etc.
- ■Due to prevent failure, PS should not be pulled after soldering with

### 6.4 Cleaning

■If you need to clean the unit, please clean it under the following conditions.

Cleaning Method: Varnishing, Ultrasonic or Vapor Cleaning

Cleaning agent: IPA (Solvent type)

Cleaning Time: Within total 2 minutes for varnishing, ultrasonic and vapor cleaning

- ■Please dry the unit sufficiently after cleaning.
- ■If you do ultrasonic cleaning, please keep the ultrasonic output at 15W/l or below.

## 7 Safety Standards

- ■To apply for a safety standard approval using the power supply, please meet the following conditions. Please contact us for details.
- Please use the unit as a component of an end device.
- ●The area between the input and the output of the unit is isolated functionally. Depending upon the input voltage, basic insulation, dual insulation or enhanced insulation may be needed. In such case, please take care of it within the structure of your end-device. Please contact us for details.
- Safety approved fuse must be externally installed on input side.

## 8 Derating

- ■It is necessary to note thermal fatigue life by power cycle. Please reduce the temperature fluctuation range as much as possible when the up and down of temperature are frequently generated.
- ■Please have sufficient ventilation to keep the temperature of point A in Fig.8.1 at Table8.1 or below. Please also make sure that the ambient temperature does not exceed 85℃.

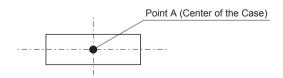


Fig. 8.1 Temperature Measuring Point on the case (Top View)

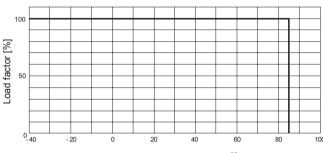
#### Table 8.1 Point A Temperature

Model	MG1R5	MG3
Point A	110℃	110℃

### 8.1 MG1R5 Derating Curve

■If you derate the output current, you can use the unit in the temperature range from -40°C to the maximum temperature shown below.





Ambient temperature Ta [℃]

Fig. 8.2 Derating Curve for Convection Cooling (Rated Input Voltage)

(2) In the case of Forced Air Cooling (1.0m/s)

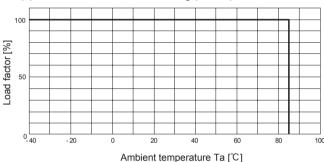


Fig. 8.3 Derating Curve for Forced Air Cooling (1.0m/s) (Rated Input Voltage)

### 8.2 MG3 Derating Curve

- ■If you derate the output current, you can use the unit in the temperature range from -40°C to the maximum temperature shown below.
  - (1) In the case of Convection Cooling

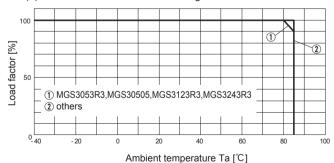
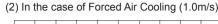


Fig. 8.4 Derating Curve for Convection Cooling (Rated Input Voltage)



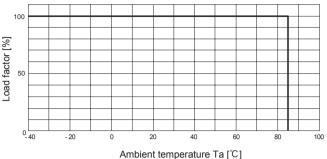


Fig. 8.5 Derating Curve for Forced Air Cooling (1.0m/s) (Rated Input Voltage)

## 9 Lifetime expectancy depends on stress by temperature difference

■Regarding lifetime expectancy design of solder joint, following contents must be considered. Be careful that the soldering joint is not stressed by temperature rise and down which occures by self-heating and ambient temperature change. The stress is accelerated by thermal-cycling, therefore the temperature difference should be minimized as much as possible if temperature rise and down occures frequently.

### 9.1 MG1R5/MG3 Lifetime expectancy depends on stress by temperature difference

■Product lifetime expectancy depends on case temperature difference (Tc) and number of cycling in a day is shown in Fig.9.1, Fig.9.2 (It is calculated based on our accelerated process test result.) If case temperature changes frequently by changing output load factor etc., the above the lifetime expectancy design should be applied as well. And point A which is shown in Fig.9.3 must keep below 110℃.

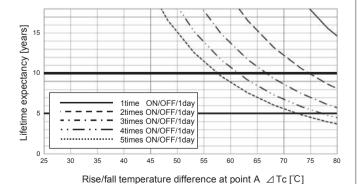


Fig9.1 Lifetime expectancy against rise/fall temperature difference (MG1R5)

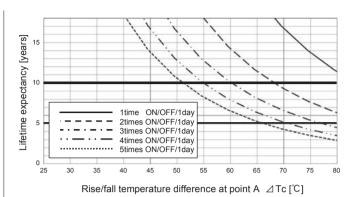


Fig9.2 Lifetime expectancy against rise/fall temperature difference (MG3)

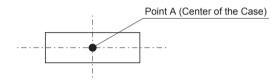


Fig.9.3 Temperature Measuring Point on the case (Top View)

■The warranty period is basically 10 years, however it depends on the lifetime expectancy which is shown in Fig9.1, Fig9.2 if it is less than 10 years.

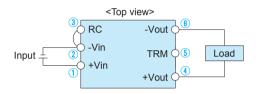


## 1 Pin Configuration

Table 1.1 Pin Configuration and Functions (MG15)

Pin No. Pin Name		Function
1	+Vin	+DC Input
2	-Vin	-DC Input
3	RC	Remote ON/OFF
4	+Vout	+DC Output
(F)	TRM	Output Voltage Adjustment (please see 2.5)
5	COM	GND of Output Voltage (for Dual Output)
6	-Vout	-DC Output

### Single Output



### Dual(±)Output

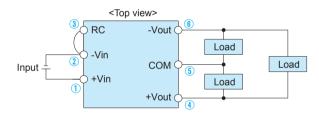
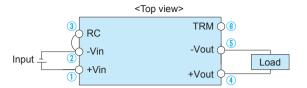


Fig.1.1 Pin Configuration (MG15)

Table 1.2 Pin Configuration and Functions (MG30)

Pin No.	Pin Name	Function
1	+Vin	+DC Input
2	-Vin	-DC Input
3	RC	Remote ON/OFF
4	+Vout	+DC Output
(F)	-Vout	-DC Output (for Single Output)
5	COM	GND of Output Voltage (for Dual Output)
	TRM	Output Voltage Adjustment (please see 2.5)
6	-Vout	-DC Output (for Dual Output)

### Single Output



### Dual(±)Output

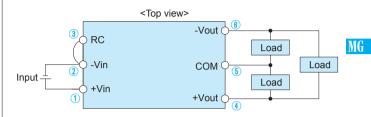


Fig.1.2 Pin Configuration (MG30)

## 2 Function

### 2.1 Input Voltage Range

■If output voltage value doesn't fall within specifications, a unit may not operate in accordance with specifications and/or fail.

#### 2.2 Overcurrent Protection

#### **■**Overcurrent Operation

An overcurrent protection circuit is built-in and activated at 105% of the rated current or above. It prevents the unit from short circuit and overcurrent for less than 20 seconds. The output voltage of the power supply will recover automatically if the fault causing over current is corrected.

When the output voltage drops after OCP works, the power supply enters a "hiccup mode" where it repeatedly turns on and off at a certain frequency.

#### 2.3 Overvoltage Protection (Excluding MG15)

■Over Voltage Protection (OVP) is built in. When OVP works, output voltage can be recovered by shutting down DC input for at least one second or by turning off the remote control switch for one second without shutting down the DC input. The recovery time varies according to input voltage and input capacitance.

#### Remarks:

Note that devices inside the power supply may fail when a voltage greater than the rated output voltage is applied from an external power supply to the output terminal of the power supply. This could happen in in-coming inspections that include OVP function test or when voltage is applied from the load circuit.

#### 2.4 Isolation

■When you run a Hi-Pot test as receiving inspection, gradually increase the voltage to start. When you shut down, decrease the voltage gradually by using a dial. Please avoid a Hi-Pot tester with a timer because, when the timer is turned ON or OFF, it may generate a voltage a few times higher than the applied voltage.

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### 2.5 Output Voltage Adjustment Range(MGS/MGFS Only)

- ■The output voltage is adjustable through an external potentiometer. Adjust only within the range of ±10% of the rated voltage.
- ■To increase the output voltage, turn the potentiometer clockwise and connect in such a way that the resistance value between 2 and 3 becomes small.

To decrease the output voltage, turn the potentiometer counterclockwise

■Please use a wire as short as possible to connect to the potentiometer and connect it from the pin on the power supply side. Temperature coefficient deteriorates when some types of resistors and potentiometers are used. Please use the following types:

Resistor----- Metal Film Type, Temperature Coefficient of t100ppm/C or below

Potentiometer... Cermet Type, Temperature Coefficient of t300ppm/C or below

- ■If output voltage adjustment is not required, open the TRM pin.
- ■Output voltage adjustment may increase to overvoltage protection activation range based on determined external resister values.

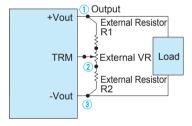


Fig.2.1 Connecting External Devices

Table 2.1 List of External Devices

		Constant of External Device $[\Omega]$				
Item #	Output Voltage	(Adju	(Adjustable within ±10%)			
		VR	R1	R2		
1	3.3V	1k	100	100		
2	5V	1k	100	270		
3	12V	5k	10k	1.5k		
4	15V	5k	10k	1k		
5	±5V					
6	±12V					
7	±15V					

#### 2.6 Remote ON/OFF

■The remote ON/OFF function is incorporated in the input circuit and operated with RC and -Vin. If positive logic control is required, order the power supply with "-R" option.

Table 2.2 Remote ON/OFF Specifications

	ON/OFF logic	Between RC and -Vin	Output voltage
Standard	Negative	L level (0 - 1.2V) or short	ON
Stanuaru	ivegative	H level (3 - 12V) or open	OFF
Optional	Danitiva	L level (0 - 1.2V) or short	OFF
-R	Positive	H level (3 - 12V) or open	ON

- ■When RC is at low level, a current of 0.5mA typ will flow out.
- ■When remote ON/OFF is not used, short RC and -Vin.

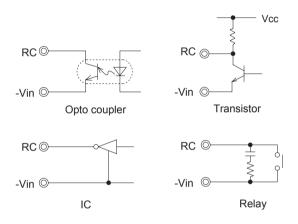


Fig.2.2 RC Connection Example

## 3 Wiring to Input/Output Pin

### 3.1 Wiring input pin

■MG series has Pi-shaped filter internally.

You can add a capacitor Ci near the input pin termilal and reduce reflected input noise from the converter. Please connect the capacitor as needed.

- ■When you use a capacitor Ci, please use the one with high frequency and good temperature characteristics.
- ■If the power supply is to be turned ON/OFF directly with a switch, inductance from the input line will induce a surge voltage several times that of the input voltage and it may damage the power supply. Make sure that the surge is absorbed, for example, by connecting an electrolytic capacitor between the input pins.

- ■If an external filter containing L (inductance) is added to the input line or a wire from the input source to the MG series is long, not only the reflected input noise becomes large, but also the output of the converter may become unstable. In such case, connecting Ci to the input pin is recommended.

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■If you use an aluminum electrolytic capacitor, please pay attention to the ripple current rating.

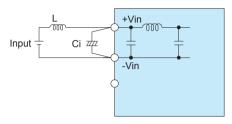


Fig.3.1 Connecting an External Capacitor to the Input Side

Table 3.1 Recommended Capacitance of an External Capacitor on the Input Side [ $\mu$ F]

Model Input Voltage[V]	MG15	MG30
12	220	220
24	100	100
48	47	47
12 - 24	100	100
24 - 48	47	47

- \*Please adjust the capacitance in accordance with a degree of the effect you want to achieve.
- ■If a reverse polarity voltage is applied to the input pin, the power supply will fail.

If there is a possibility that a reverse polarity voltage is applied, connect a protection circuit externally as described below.

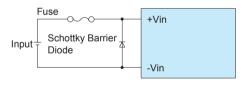


Fig.3.2 Connecting a Reverse Voltage Protection Circuit

#### 3.2 Wiring output pin

■If you want to further reduce the output ripple noise, connect an electrolytic capacitor or a ceramic capacitor Co to the output pin as shown below.

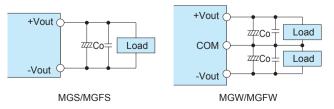


Fig.3.3 Connecting Example of an External Capacitor to the Output Side

Table 3.2 Recommended Capacitance of External Capacitor on the Output Side [ $\mu$ F]

Model Output Voltage[V]	MG15	MG30
3.3	470	470
5	470	470
12	150	150
15	100	100
±5	330	330
±12	100	100
±15	47	47

- \*If you use a ceramic capacitor, keep the capacitance within the rage between about 0.1 to  $22\mu$  F.
- \*Please adjust the capacitance in light of the effect you want to
- \*If you need to use an unproven external capacitor which capacitance moreover the range provided in Table 3.2, please contact us for the assistance.
- ■If the distance between the output and the load is long and therefore the noise is generated on the load side, connect a capacitor externally to the load as shown below.

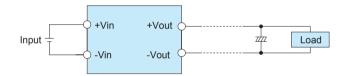


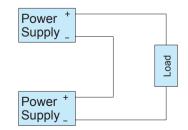
Fig.3.4 Connecting Example

## 4 Series/Parallel Operation

### 4.1 Series Operation

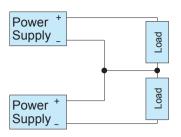
■You can use the power supplies in series operation by wiring as shown below. In the case of (a) below, the output current should be lower than the rated current for each power supply with the lowest rated current among power supplies that are serially connected. Please make sure that no current exceeding the rated current flows into a power supply.

(a)



(b)

MG



DC-DC Converters PCB Mount Type

Fig.4.1 Series Operation

### 4.2 Redundancy Operation

■You can use the power supplies in redundancy operation by wiring as shown below.

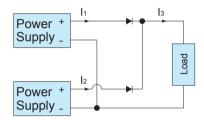


Fig.4.2 Redundancy Operation

■Even a slight difference in output voltage can affect the balance between the values of I1 and I2.

Please make sure that the value of 13 does not exceed the rated current for each power supply.

I<sub>3</sub> ≤ Rated Current Value

## 5 Input Voltage/ **Current Range**

- ■If you use a non-regulated power source for input, please check and make sure that its voltage fluctuation range and ripple voltage do not exceed the input voltage range shown in specifications.
- ■Please select an input power source with enough capacity, taking into consideration of the start-up current (Ip), which flows when a DC-DC converter starts up.

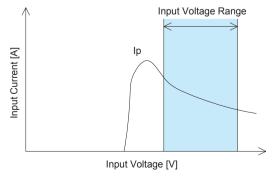


Fig.5.1 Input Current Characteristics

## 6 Assembling and Installation

#### 6.1 Installation

■When two or more power supplies are used side by side, position them with proper intervals to allow enough air ventilation. Ambient temperature around each power supply should not exceed the temperature range shown in derating curve.

### 6.2 Hand Mounting

■Due to prevent failure, PS should not be pull after soldering with

### 6.3 Soldering Conditions

: 260℃ (1) Flow Soldering 15 seconds or less (2) Soldering Iron : maximum 360°C 5 seconds or less

#### 6.4 Stress to Pin

- ■Applying excessive stress to the input or output pins of the power module may damage internal connections. Avoid applying stress in excess of that shown in Fig. 6.1.
- ■Input/output pin are soldered to the PCB internally. Do not pull or bend a lead powerfully.
- ■If it is expected that stress is applied to the input/output pin due to vibration or impact, reduce the stress to the pin by taking such measures as fixing the unit to the PCB by silicone rubber, etc.

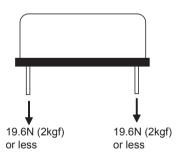


Fig.6.1 Stress onto Pins

### 6.5 Cleaning

■If you need to clean the unit, please clean it under the following conditions.

Cleaning Method: Varnishing, Ultrasonic or Vapor Cleaning

Cleaning agent: IPA (Solvent type)

Cleaning Time: Within total 2 minutes for varnishing, ultrasonic and vapor cleaning

- ■Please dry the unit sufficiently after cleaning.
- ■If you do ultrasonic cleaning, please keep the ultrasonic output at 15W/l or below.

## 7 Safety Standards

- ■To apply for a safety standard approval using the power supply, please meet the following conditions. Please contact us for de-
- Please use the unit as a component of an end device.
- ■The area between the input and the output of the unit is isolated functionally. Depending upon the input voltage, basic insulation, dual insulation or enhanced insulation may be needed. In such case, please take care of it within the structure of your end-device. Please contact us for details.

## 8 Derating

#### 8.1 MG15 / MGF15 Derating Curve

- ■If you derate the output current, you can use the unit in the temperature range from -40°C to the maximum temperature shown below.
- (1) In the case of Convection Cooling

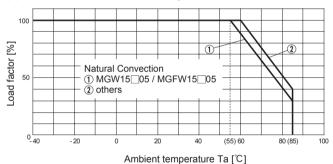


Fig. 8.1 Derating Curve for Convection Cooling (Rated Input Voltage)

(2) In the case of Forced Air Cooling (1.0m/s)(Excluding MGW15 05/MGFW15 05)

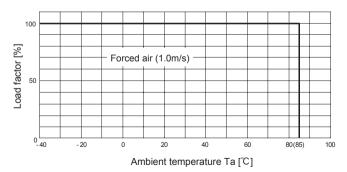


Fig. 8.2 Derating Curve for Forced Air Cooling (1.0m/s) (Rated Input Voltage)

(3) In the case of Forced Air Cooling (1.0m/s, 2.5m/s)(MGW15 05/ MGFW15□05)

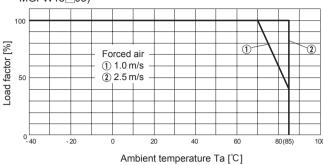


Fig. 8.3 Derating Curve for Forced Air Cooling (1.0m/s,2.5m/s) (Rated Input Voltage)

- (4) Temperature Measuring Point on the case.
- ■In case of forced air cooling, please have sufficient ventilation to keep the temperature of point A in Fig.8.4 at 105°C or below.

Please also make sure that the ambient temperature does not exceed 85°C.

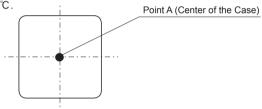


Fig. 8.4 Temperature Measuring Point on the case (Top View)

#### 8.2 MG30 / MGF30 Derating Curve

- ■If you derate the output current, you can use the unit in the temperature range from -40  $\!\!\!^{\,\circ}\!\!\!\!^{\,\circ}$  to the maximum temperature shown
- (1) In the case of Convection Cooling

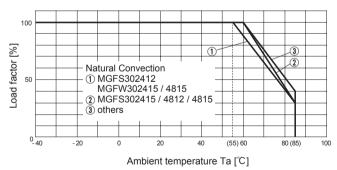


Fig. 8.5 Derating Curve for Convection Cooling (Rated Input Voltage)

MG

(2) In the case of Forced Air Cooling (1.0m/s)(Excluding MGW30 05 and MGFW30 12/15)

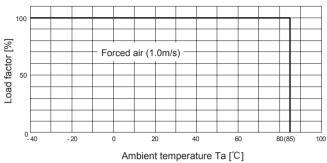


Fig. 8.6 Derating Curve for Forced Air Cooling (1.0m/s) (Rated Input Voltage)

(3) In the case of Forced Air Cooling (1.0m/s, 1.5m/s)(MGW30 □ 05 and MGFW30 12/15)

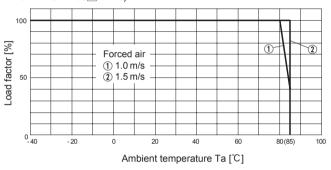


Fig. 8.7 Derating Curve for Forced Air Cooling (1.0m/s,1.5m/s) (Rated Input Voltage)

(4) Temperature Measuring Point on the case.

■In case of forced air cooling, please have sufficient ventilation to keep the temperature of point A in Fig.8.8 at 110°C or below.

Please also make sure that the ambient temperature does not exceed 85℃.

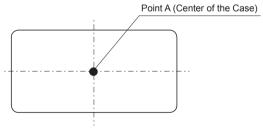
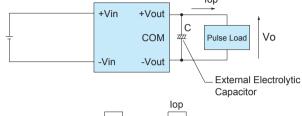
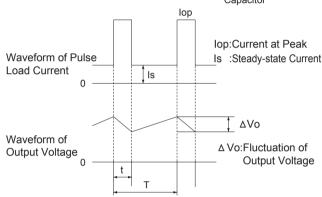


Fig. 8.8 Temperature Measuring Point on the case (Top View)

## 9 Peak Current (Pulse Load)

■If a load connected to a converter is a pulse load, you can provide a pulse current by connecting an electrolytic capacitor externally to the output side.





■The average output current lav is expressed in the following formula.

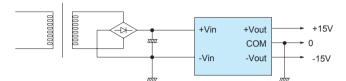
$$lav = ls + \frac{(lop - ls) \times t}{T}$$

■Required electrolytic capacitor C can be obtained from the following formula.

$$C = \frac{(lop - lav) \times t}{\Delta Vo}$$

## 10 Using DC-DC Converters

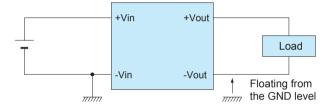
■When using AC power source



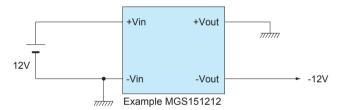
■When using a battery-operated device



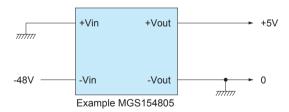
■When a floating mechanism is required for the output circuit



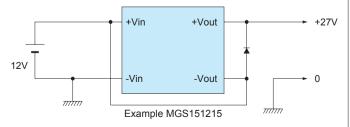
■To draw a reverse polarity output



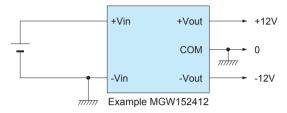
■To provide a negative voltage to -Vin by using +Vin side of the converter as GND potential (0V)



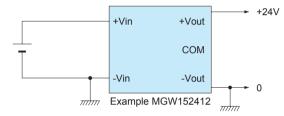
■To draw the sum of input voltage and plus output voltage



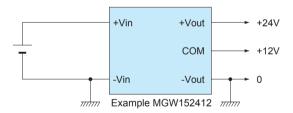
- \*Output current should be the same as the rated output current of the converter.
- \*Output current fluctuation is the sum of the input voltage fluctuation and the output voltage fluctuation of the converter.
- ■To use a dual output type
- \*Dual output type is typically used in the following manner.



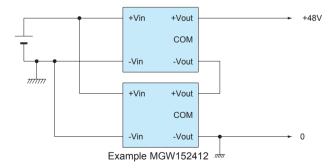
\*The unit can be used as a 24V type single output power supply as follows.



- \*Another way to use the unit is described below.
- \*The sum of +12V and +24V flows to the 0V line. Please make sure that this value does not exceed the rated output current of the converter.



■To draw 48V output



## Note to use ±5V output

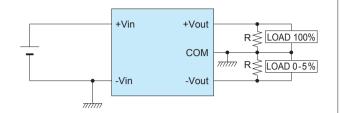


Fig.11.1 Example of decreasing the fluctuation of output voltage.

■If an output current is 0% to 5% of the rated current, the output is influenced by the other output load condition.

20% output voltage fluctuation may occer.

To avoid the fluctuation, external bleeding resister is required to draw sufficient current.

## 12 Lifetime expectancy depends on stress by temperature difference

■Regarding lifetime expectancy design of solder joint, following contents must be considered.

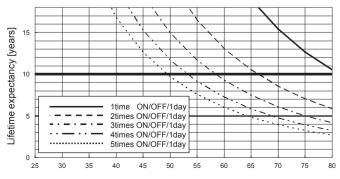
It must be careful that the soldering joint is stressed by temperature rise and down which is occurred by self-heating and ambient

The stress is accelerated by thermal-cycling, therefore the temperature difference should be minimized as much as possible if temperature rise and down is occurred frequently.

#### 12.1 MG15 / MGF15 Lifetime expectancy depends on stress by temperature difference

■Product lifetime expectancy depends on case temperature difference (∠Tc) and number of cycling in a day is shown in Fig.12.1 (It is calculated based on our accelerated process test result.)

If case temperature changes frequently by changing output load factor etc., the above the lifetime expectancy design should be applied as well. And point A which is shown in Fig.12.2 must keep below 105℃



Rise/fall temperature difference at point A ⊿Tc [°C]

Fig.12.1 Lifetime expectancy against rise/fall temperature difference

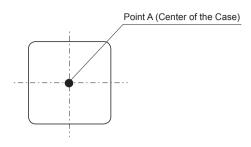
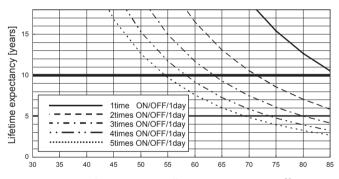


Fig.12.2 Temperature measuring point (Top View)

■The warranty period is basically 10 years, however it depends on the lifetime expectancy which is shown in Fig.12.1 if it is less than 10 years.

#### 12.2 MG30 / MGF30 Lifetime expectancy depends on stress by temperature difference

■Product lifetime expectancy depends on case temperature difference (∠Tc) and number of cycling in a day is shown in Fig.12.3 (It is calculated based on our accelerated process test result.) If case temperature changes frequently by changing output load factor etc., the above the lifetime expectancy design should be applied as well. And point A which is shown in Fig.12.4 must keep below 110℃.



Rise/fall temperature difference at point A ⊿Tc [°C]

Fig.12.3 Lifetime expectancy against rise/fall temperature difference

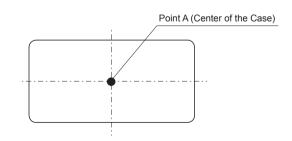


Fig.12.4 Temperature measuring point (Top View)

■The warranty period is basically 10 years, however it depends on the lifetime expectancy which is shown in Fig.12.3 if it is less than 10 years.